

Single P-Channel MOSFET

DESCRIPTION

SMC3327 is the P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced trench technology devices are well suited for high efficiency fast switching applications, low in-line power loss needed in small outline surface mount package.

PART NUMBER INFORMATION

SMC 3327 SN - TR G
 a b c d e

a : Company name.
 b : Product Serial number.
 c : Package code SN: SOT-23
 d : Handling code TR: Tape&Reel
 e : Green produce code G: *RoHS Compliant*

FEATURES

$V_{DS} = -30V$, $I_D = -4A$

$R_{DS(ON)} = 45m\Omega (Typ.) @ V_{GS} = -10V$

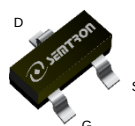
$R_{DS(ON)} = 52m\Omega (Typ.) @ V_{GS} = -4.5V$

$R_{DS(ON)} = 68m\Omega (Typ.) @ V_{GS} = -2.5V$

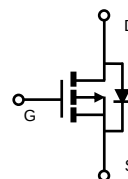
- ◆ Fast switch
- ◆ 2.5V Low gate drive applications

APPLICATIONS

- ◆ Portable Equipment
- ◆ Power Management



SOT-23



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless otherwise noted)

Symbol	Parameter	Rating	Units
V_{DSS}	Drain-Source Voltage	-30	V
V_{GSS}	Gate-Source Voltage	± 12	V
I_D	Continuous Drain Current	$T_A = 25^\circ C$	-4
		$T_A = 70^\circ C$	-3.1
I_{DM}	Pulsed Drain Current ^A	-16	A
P_D	Power Dissipation ^C	$T_A = 25^\circ C$	1.3
		$T_A = 70^\circ C$	0.8
T_J	Operation Junction Temperature	-55/150	$^\circ C$
T_{STG}	Storage Temperature Range	-55/150	$^\circ C$

THERMAL RESISTANCE

Symbol	Parameter	Typ	Max	Units
$R_{\theta JA}$	Thermal Resistance Junction to Ambient ^B	$t \leq 10s$	95	$^\circ C/W$
	Thermal Resistance Junction to Ambient ^{BD}	Steady-State	130	

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless otherwise noted)

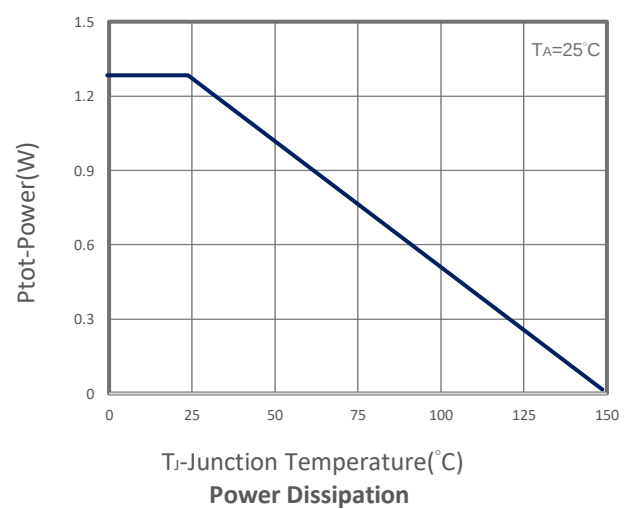
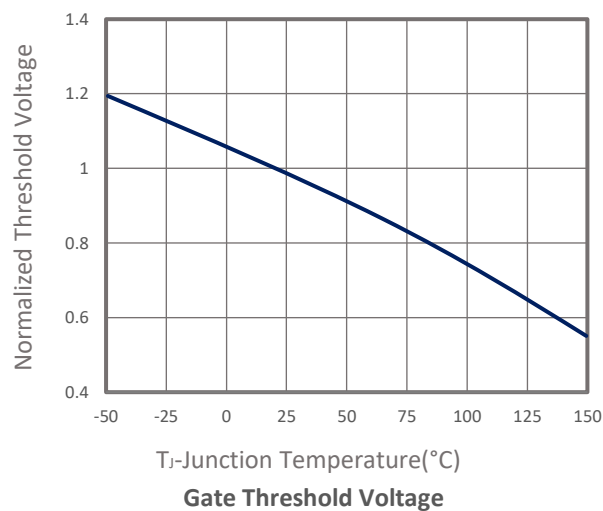
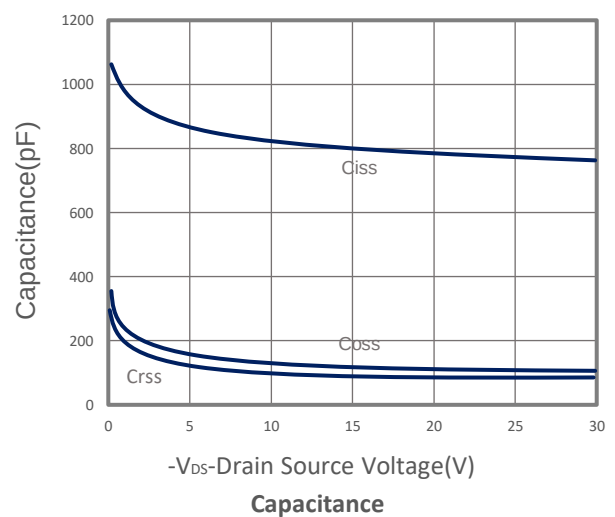
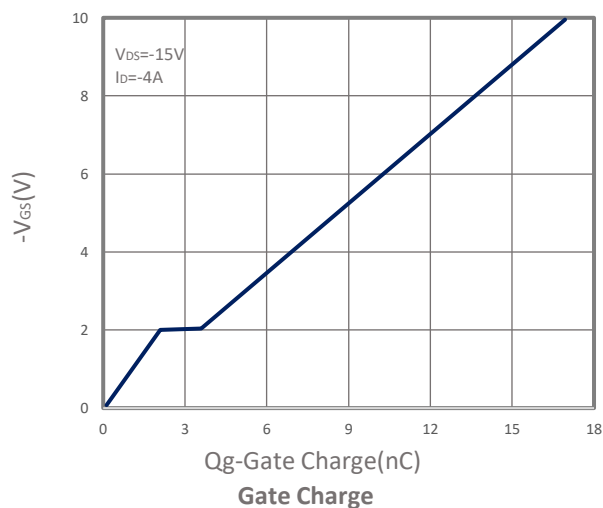
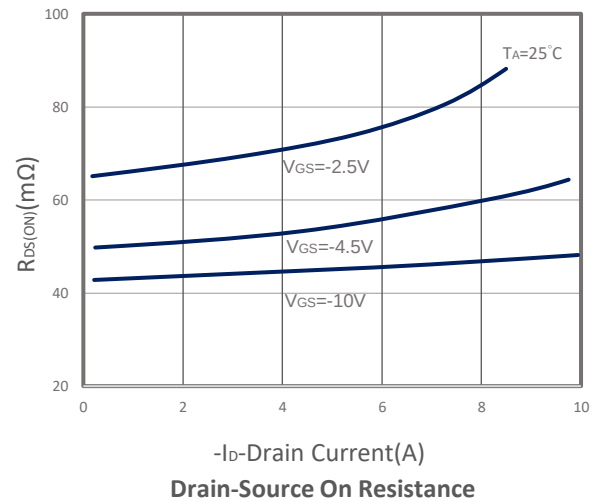
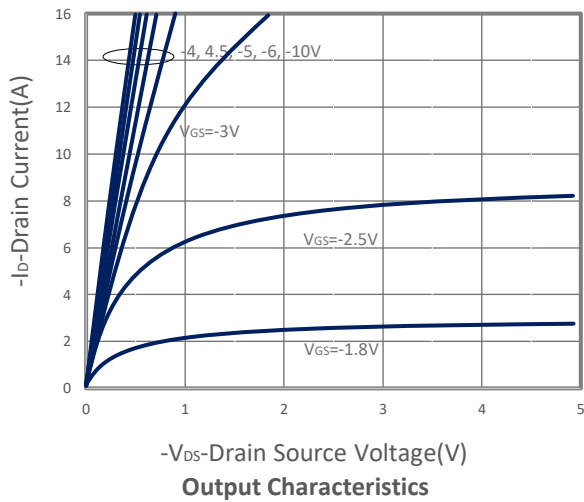
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Parameters						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-30			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-0.5	-0.7	-1	V
I _{GSS}	Gate Leakage Current	V _{DS} =0V, V _{GS} =±12V			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V, T _J =25°C			-1	μA
		V _{DS} =-24V, V _{GS} =0V, T _J =75°C			-10	
R _{DS(ON)}	Drain-source On-Resistance	V _{GS} =-10V, I _D =-4A		45	54	mΩ
		V _{GS} =-4.5V, I _D =-3A		52	62	
		V _{GS} =-2.5V, I _D =-2.2A		68	85	
G _{fs}	Forward Transconductance	V _{DS} =-10V, I _D =-7A		5.7		S
Diode Characteristics						
V _{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V		-0.7	-1	V
I _S	Continuous Source Current				-4	A
Dynamic and Switching Parameters						
Q _g	Total Gate Charge	V _{DS} =-15V, V _{GS} =-10V, I _D =-4A		16.8	23.5	nC
Q _g	Total Gate Charge(4.5V)			8.2	11.5	
Q _{gs}	Gate-Source Charge			2	2.8	
Q _{gd}	Gate-Drain Charge			1.5	2.1	
C _{iss}	Input Capacitance	V _{DS} =-15V, V _{GS} =0V, f=1MHz		805		pF
C _{oss}	Output Capacitance			87		
C _{rss}	Reverse Transfer Capacitance			48		
t _{d(on)}	Turn-On Time	V _{DD} =-15V, V _{GEN} =-10V R _G =6Ω, I _D =-1A		5.6	11	nS
t _r				8.2	16	
t _{d(off)}	Turn-Off Time			36.5	69	
t _f				9.6	18	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

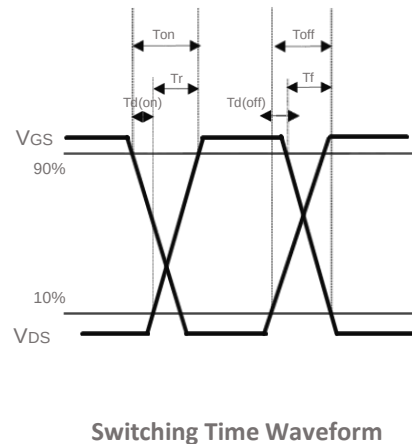
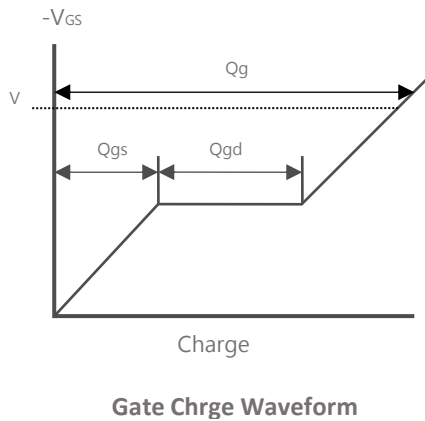
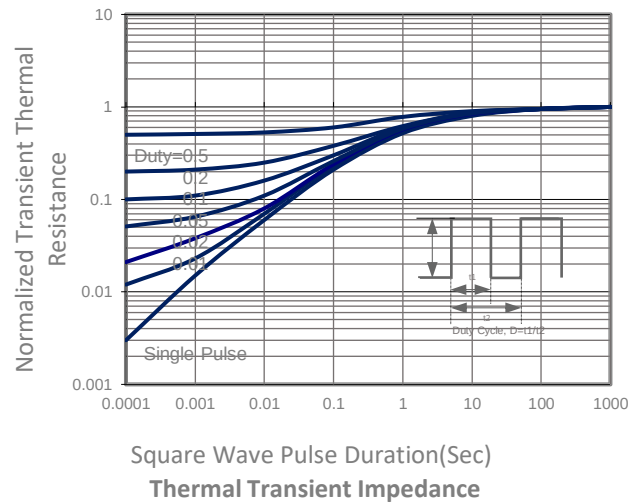
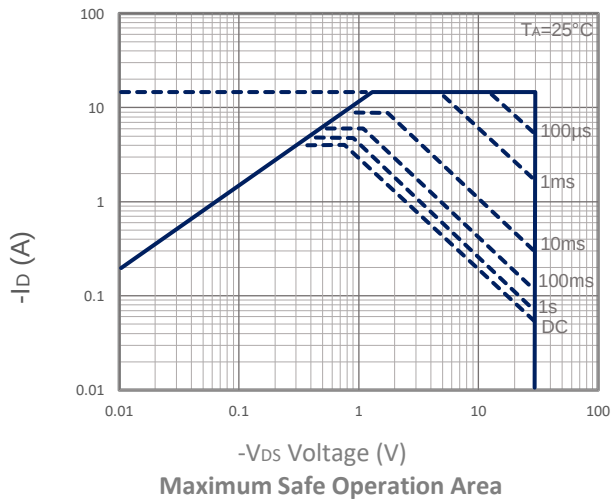
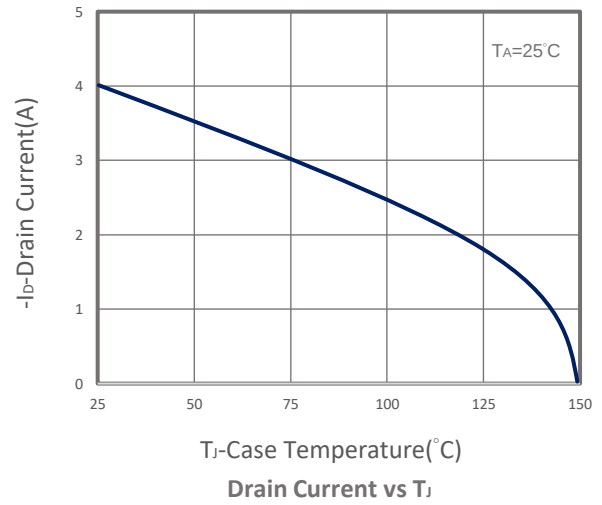
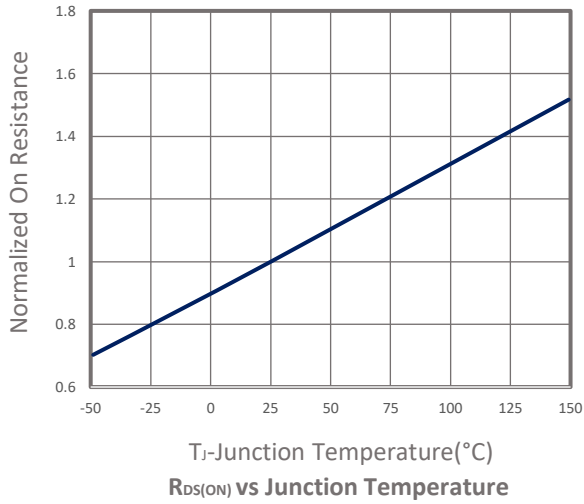
- Pulsed width limited by maximum junction temperature, $T_{J(MAX)}=150^\circ\text{C}$.
- Measure the value in a still air environment at $T_A=25^\circ\text{C}$, using an installation mounted on a 1 in2 FR-4 board, maximum junction temperature $T_{J(MAX)}=150^\circ\text{C}$.
- $T_{J(MAX)}=150^\circ\text{C}$, using junction-to-case thermal resistance ($R_{\theta JC}$) is more useful in additional heat sinking is used.

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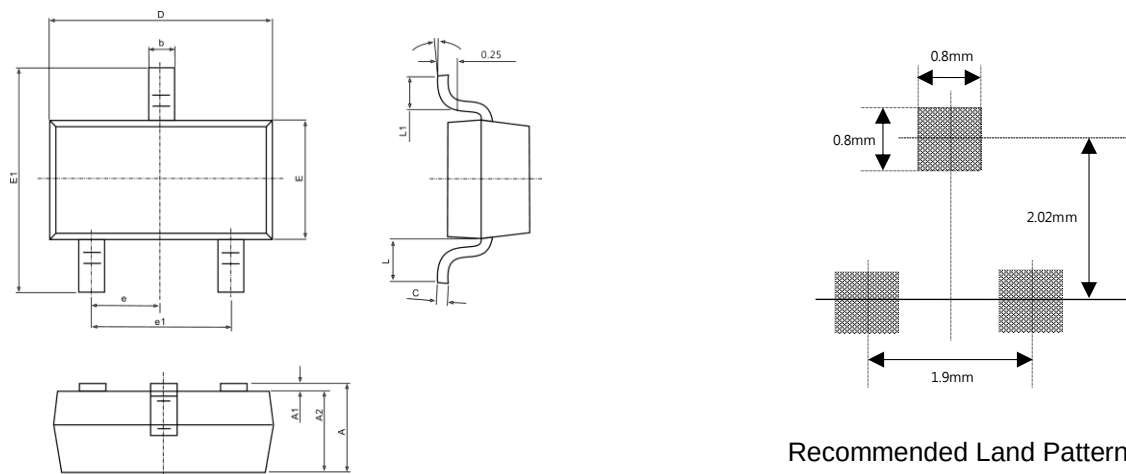
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



SOT-23 PACKAGE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°